L Number	Hits	Search Text	DB	Time stamp
1	79	257/$.ccls. and ((dop$6 or implant$6) same silicid$6 same nitride same (hydrogen or ("H.sub.2")) same (nitrogen or ("N.sub.2")))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/24 09:54
2	66	438/$.ccls. and ((dop$6 or implant$6) same silicid$6 same nitride same (hydrogen or ("H.sub.2")) same (nitrogen or ("N.sub.2")))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/24 09:54
4	1	semiconductor and ((dop$6 or implant$6) with silicid$6 with nitride with (hydrogen or ("H.sub.2")) with (nitrogen or ("N.sub.2")))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/24 09:55
3	90	semiconductor and ((dop$6 or implant$6) same silicid$6 same nitride same (hydrogen or ("H.sub.2")) same (nitrogen or ("N.sub.2")))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/24 12:07
8	3	("6605549").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/24 12:16
-	3	(("6121134") or ("5639678") or ("4701349")).PN.	USPAT	2004/09/23 10:48
-	1649	(438/655).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/23 13:50
-	733	(438/652).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/23 13:50
-	307	(438/308).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/23 14:04
-	602	438/581,583,592,308,652,655,649,651,682.ccls and (dop$6 or implant$6) and silicid$6 and (hydrogen or ("H.sub.2")) and (nitrogen or ("N.sub.2"))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/23 14:23
-	3661	438/$.ccls. and (dop$6 or implant$6) and silicid$6 and (hydrogen or ("H.sub.2")) and (nitrogen or ("N.sub.2"))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/23 14:24
-	4738	257/$.ccls. and (dop$6 or implant$6) and silicid$6 and (hydrogen or ("H.sub.2")) and (nitrogen or ("N.sub.2"))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/23 14:24
-	1	257/$.ccls. and ((dop$6 or implant$6) with silicid$6 with (hydrogen or ("H.sub.2")) with (nitrogen or ("N.sub.2")))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/23 14:25
-	2	("4429011" | "4545116").PN.	USPAT	2004/09/23 14:26
-	40	4701349.URPN.	USPAT	2004/09/23 14:27
-	2	("4429011" | "4545116").PN.	USPAT	2004/09/23 14:30
-	157	257/$.ccls. and ((dop$6 or implant$6) same silicid$6 same (hydrogen or ("H.sub.2")) same (nitrogen or ("N.sub.2")))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/24 09:53